

6367254 MOTOROLA SC (XSTRS/R F)

96D 82498 D

**MPQ2906, 2907** For Specifications, See MHQ2906 Data.

**MAXIMUM RATINGS**

| Rating   | Symbol                            | Value                        | Unit |       |
|--|-----------------------------------|------------------------------|------|-------|
| Collector-Emitter Voltage  | V <sub>CEO</sub>                  | 12                           | Vdc  |       |
| Collector-Base Voltage   | V <sub>CBO</sub>                  | 25                           | Vdc  |       |
| Emitter-Base Voltage   | V <sub>EBO</sub>                  | 4.0                          | Vdc  |       |
| Collector Current — Continuous   | I <sub>C</sub>                    | 1.0                          | Adc  |       |
| Total Device Dissipation<br>@ T <sub>A</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | Each Transistor              | 650  | mW    |
|  |                                   | Four Transistors Equal Power | 1250 | mW    |
| Total Device Dissipation<br>@ T <sub>C</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub> '                  | Each Transistor              | 1.0  | Watts |
|  |                                   | Four Transistors Equal Power | 3.0  | Watts |
| Operating and Storage Junction Temperature Range                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150                  | °C   |       |

**THERMAL CHARACTERISTICS**

| Characteristic     | Each Die         | Junction to Case | Junction to Ambient | Unit |
|--------------------|------------------|------------------|---------------------|------|
| Thermal Resistance | Each Die         | 125              | 193*                | °C/W |
|                    | Effective, 4 Die | 41.6             | 100*                | °C/W |
| Coupling Factors   | Q1-Q4 or Q2-Q3   | 30               | 60                  | %    |
|                    | Q1-Q2 or Q3-Q4   | 2.0              | 25                  | %    |

(1) R<sub>θJA</sub> is measured with the device soldered into a typical printed circuit board.

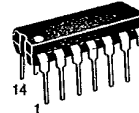
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted.)**

| Characteristic  | Symbol               | Min      | Typ          | Max         | Unit |
|---|----------------------|----------|--------------|-------------|------|
| <b>OFF CHARACTERISTICS</b>  |                      |          |              |             |      |
| Collector-Emitter Breakdown Voltage<br>(I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0)   | V <sub>(BR)CEO</sub> | 12       | —            | —           | Vdc  |
| Collector-Base Breakdown Voltage<br>(I <sub>C</sub> = 100 μAdc, I <sub>E</sub> = 0)   | V <sub>(BR)CBO</sub> | 25       | —            | —           | Vdc  |
| Emitter-Base Breakdown Voltage<br>(I <sub>E</sub> = 100 μAdc, I <sub>C</sub> = 0)   | V <sub>(BR)EBO</sub> | 4.0      | —            | —           | Vdc  |
| Collector Cutoff Current<br>(V <sub>CE</sub> = 15 Vdc, V <sub>BE</sub> = 0)   | I <sub>CES</sub>     | —        | —            | 100         | μAdc |
| <b>ON CHARACTERISTICS</b>   |                      |          |              |             |      |
| DC Current Gain<br>(I <sub>C</sub> = 100 mAdc, V <sub>CE</sub> = 0.5 Vdc)<br>(I <sub>C</sub> = 300 mAdc, V <sub>CE</sub> = 0.5 Vdc)                   | h <sub>FE</sub>      | 30<br>40 | 45<br>55     | —<br>200    | —    |
| Collector-Emitter Saturation Voltage<br>(I <sub>C</sub> = 300 mAdc, I <sub>B</sub> = 30 mAdc)<br>(I <sub>C</sub> = 1.0 Adc, I <sub>B</sub> = 0.1 Adc) | V <sub>CE(sat)</sub> | —<br>—   | 0.22<br>0.52 | 0.33<br>0.7 | Vdc  |
| Base-Emitter Saturation Voltage<br>(I <sub>C</sub> = 300 mAdc, I <sub>B</sub> = 30 mAdc)<br>(I <sub>C</sub> = 1.0 Adc, I <sub>B</sub> = 0.1 Adc)      | V <sub>BE(sat)</sub> | —<br>—   | 0.87<br>1.04 | 1.1<br>1.4  | Vdc  |
| <b>SMALL-SIGNAL CHARACTERISTICS</b>   |                      |          |              |             |      |
| Current-Gain — Bandwidth Product<br>(I <sub>C</sub> = 100 mAdc, V <sub>CE</sub> = 5.0 Vdc, f = 100 MHz)   | f <sub>T</sub>       | 400      | 500          | —           | MHz  |
| Output Capacitance<br>(V <sub>CB</sub> = 5.0 Vdc, I <sub>E</sub> = 0, f = 1 MHz)  | C <sub>obo</sub>     | —        | 5.0          | 10          | pF   |
| Input Capacitance<br>(V <sub>BE</sub> = 0.5 Vdc, I <sub>C</sub> = 0, f = 1 MHz)   | C <sub>ibo</sub>     | —        | 22           | 30          | pF   |
| <b>SWITCHING CHARACTERISTICS</b>  |                      |          |              |             |      |
| Turn-On Time<br>(V <sub>CC</sub> = 12 Vdc, I <sub>C</sub> = 1.0 Adc, V <sub>BE(off)</sub> = 4.0 Vdc, I <sub>B1</sub> = 100 mAdc)                      | t <sub>on</sub>      | —        | 12           | 15          | ns   |
| Turn-Off Time<br>(V <sub>CC</sub> = 12 Vdc, I <sub>C</sub> = 1.0 Adc, I <sub>B1</sub> = I <sub>B2</sub> = 100 mAdc)                                   | t <sub>off</sub>     | —        | 18           | 25          | ns   |

T-43-a5

**MPQ3303**

CASE 646-06, STYLE 1  
TO-116



**QUAD  
SWITCHING TRANSISTOR**

NPN SILICON

5

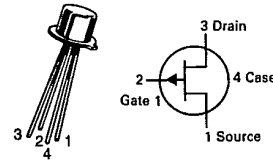
6367254 MOTOROLA SC (XSTRS/R F)

96D 82543 D

T-35-25

**2N3993,A**  
**2N3994**

CASE 20-03, STYLE 5  
TO-72 (TO-206AF)



**JFET**  
**SWITCHING**  
P-CHANNEL — DEPLETION

**MAXIMUM RATINGS**

| Rating   | Symbol    | Value       | Unit        |
|--|-----------|-------------|-------------|
| Drain-Source Voltage   | $V_{DS}$  | -25         | Vdc         |
| Drain-Gate Voltage   | $V_{DG}$  | -25         | Vdc         |
| Reverse Gate-Source Voltage  | $V_{GSR}$ | 25          | Vdc         |
| Forward Gate Current   | $I_{GF}$  | 10          | mAdc        |
| Total Device Dissipation @ $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$     | 300<br>2.0  | mW<br>mW/°C |
| Storage Temperature Range  | $T_{stg}$ | -65 to +200 | °C          |

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

| Characteristic   | Symbol        | Min               | Max                      | Unit                    |
|--|---------------|-------------------|--------------------------|-------------------------|
| <b>OFF CHARACTERISTICS</b>   |               |                   |                          |                         |
| Gate-Source Breakdown Voltage<br>( $I_G = 1.0 \mu\text{Adc}$ , $V_{DS} = 0$ )  | $V_{(BR)GSS}$ | 25                | —                        | Vdc                     |
| Drain Reverse Current<br>( $V_{DG} = -15 \text{ Vdc}$ , $I_S = 0$ )<br>( $V_{DG} = -15 \text{ Vdc}$ , $I_S = 0$ , $T_A = 150^\circ\text{C}$ )  | $I_{DGO}$     | —                 | 1.2<br>1.2               | nAdc<br>$\mu\text{Adc}$ |
| Drain Cutoff Current<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 10 \text{ Vdc}$ )<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 6.0 \text{ Vdc}$ )<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 10 \text{ Vdc}$ , $T_A = 150^\circ$ )<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 6.0 \text{ Vdc}$ , $T_A = 150^\circ$ ) | $I_{D(off)}$  | —                 | 1.2<br>1.2<br>1.0<br>1.0 | nAdc<br>$\mu\text{Adc}$ |
| Gate Source Voltage<br>( $V_{DS} = -10 \text{ Vdc}$ , $I_D = -1.0 \mu\text{Adc}$ )   | $V_{GS}$      | 4.0<br>1.0        | 9.5<br>5.5               | Vdc                     |
| <b>ON CHARACTERISTICS</b>  |               |                   |                          |                         |
| Zero-Gate-Voltage Drain Current(1)<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 0$ )  | $I_{DSS}$     | 10<br>2.0         | —<br>—                   | mAdc                    |
| <b>SMALL-SIGNAL CHARACTERISTICS</b>  |               |                   |                          |                         |
| Drain-Source "ON" Resistance<br>( $V_{GS} = 0$ , $I_D = 0$ , $f = 1.0 \text{ kHz}$ )   | $r_{ds(on)}$  | —<br>—            | 150<br>300               | Ohms                    |
| Forward Transfer Admittance(1)<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1.0 \text{ kHz}$ )  | $ y_{fs} $    | 6.0<br>7.0<br>4.0 | 12<br>12<br>10           | mmhos                   |
| Input Capacitance<br>( $V_{DS} = -10 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1.0 \text{ MHz}$ )   | $C_{iss}$     | —<br>—            | 16<br>12                 | pF                      |
| Reverse Transfer Capacitance<br>( $V_{DS} = 0$ , $V_{GS} = 10 \text{ Vdc}$ , $f = 1.0 \text{ MHz}$ )<br><br>( $V_{DS} = 0$ , $V_{GS} = 6.0 \text{ Vdc}$ , $f = 1.0 \text{ MHz}$ )  | $C_{rss}$     | —<br>—<br>—       | 4.5<br>3.0<br>5.0        | pF                      |

(1) Pulse Test: Pulse Width = 100 ms, Duty Cycle  $\leq 10\%$ .



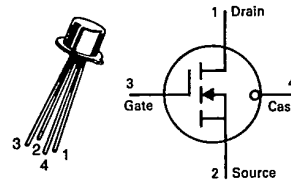
6367254 MOTOROLA SC (XSTRS/R F)

96D 82603 D

T-37-25

3N157  
3N158

CASE 20-03, STYLE 2  
TO-72 (TO-206AF)



MOSFET  
AMPLIFIER AND SWITCHING

P-CHANNEL — ENHANCEMENT

MAXIMUM RATINGS

| Rating   | Symbol           | Value       | Unit        |
|--|------------------|-------------|-------------|
| Drain-Source Voltage*  | V <sub>DS</sub>  | ±35         | Vdc         |
| Drain-Gate Voltage*  | V <sub>DG</sub>  | ±50         | Vdc         |
| Gate-Source Voltage*   | V <sub>GS</sub>  | ±50         | Vdc         |
| Drain Current*   | I <sub>D</sub>   | 30          | mAdc        |
| Total Device Dissipation @ T <sub>A</sub> = 25°C<br>Derate above 25°C* | P <sub>D</sub>   | 300<br>1.7  | mW<br>mW/°C |
| Junction Temperature Range*  | T <sub>J</sub>   | -65 to +175 | °C          |
| Storage Channel Temperature Range*                                     | T <sub>stg</sub> | -65 to +175 | °C          |

\*JEDEC Registered Limits

ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted.)

| Characteristic   | Symbol               | Min          | Typ                  | Max                         | Unit                         |
|--|----------------------|--------------|----------------------|-----------------------------|------------------------------|
| <b>OFF CHARACTERISTICS</b>   |                      |              |                      |                             |                              |
| Drain-Source Breakdown Voltage (I <sub>D</sub> = -10 μAdc, V <sub>G</sub> = V <sub>S</sub> = 0)  | V <sub>(BR)DSX</sub> | -35          | —                    | —                           | Vdc                          |
| Zero-Gate-Voltage Drain Current (V <sub>DS</sub> = -15 Vdc, V <sub>GS</sub> = 0)<br>(V <sub>DS</sub> = -35 Vdc, V <sub>GS</sub> = 0)   | I <sub>DSS</sub>     | —            | —                    | -1.0<br>-10                 | nAdc<br>μAdc                 |
| Gate Reverse Current* (V <sub>GS</sub> = +25 Vdc, V <sub>DS</sub> = 0)<br>(V <sub>GS</sub> = +50 Vdc, V <sub>DS</sub> = 0)   | I <sub>GSS</sub>     | —            | —                    | +10<br>+10                  | pAdc<br>nAdc                 |
| Input Resistance (V <sub>GS</sub> = -25 Vdc)   | R <sub>GS</sub>      | —            | 1 x 10 <sup>12</sup> | —                           | Ohms                         |
| Gate Source Voltage* (V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -0.5 mAdc)   | V <sub>GS</sub>      | -1.5<br>-3.0 | —                    | -5.5<br>-7.0                | Vdc                          |
| Gate Forward Current* (V <sub>GS</sub> = -25 Vdc, V <sub>DS</sub> = 0)<br>(V <sub>GS</sub> = -50 Vdc, V <sub>DS</sub> = 0)<br>(V <sub>GS</sub> = -25 Vdc, V <sub>DS</sub> = 0, T <sub>A</sub> = +55°C)<br>(V <sub>GS</sub> = -50 Vdc, V <sub>DS</sub> = 0, T <sub>A</sub> = +55°C) | I <sub>G(f)</sub>    | —            | —                    | -10<br>-1.0<br>-1.0<br>-1.0 | pAdc<br>nAdc<br>nAdc<br>μAdc |

ON CHARACTERISTICS

|  |                     |              |   |              |      |
|--|---------------------|--------------|---|--------------|------|
| Gate Threshold Voltage* (V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -10 μAdc) | V <sub>GS(Th)</sub> | -1.5<br>-3.0 | — | -3.2<br>-5.0 | Vdc  |
| On-State Drain Current* (V <sub>DS</sub> = -15 Vdc, V <sub>GS</sub> = -10 Vdc) | I <sub>D(on)</sub>  | -5.0         | — | —            | mAdc |

SMALL-SIGNAL CHARACTERISTICS

|   |                     |      |            |          |        |
|---|---------------------|------|------------|----------|--------|
| Forward Transfer Admittance* (V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -2.0 mAdc, f = 1.0 kHz)   | y <sub>fs</sub>     | 1000 | —          | 4000     | μmhos  |
| Output Admittance* (V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -2.0 mAdc, f = 1.0 kHz)   | y <sub>os</sub>     | —    | —          | 60       | μmhos  |
| Input Capacitance* (V <sub>DS</sub> = -15 Vdc, V <sub>GS</sub> = 0, f = 140 kHz)  | C <sub>iss</sub>    | —    | —          | 5.0      | pF     |
| Reverse Transfer Capacitance* (V <sub>DS</sub> = -15 Vdc, V <sub>GS</sub> = 0, f = 140 kHz)   | C <sub>rss</sub>    | —    | —          | 1.3      | pF     |
| Drain-Substrate Capacitance (V <sub>D(SUB)</sub> = -10 Vdc, f = 140 kHz)  | C <sub>d(sub)</sub> | —    | —          | 4.0      | pF     |
| Noise Voltage (R <sub>S</sub> = 0, BW = 1.0 Hz, V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -2.0 mAdc, f = 100 Hz)<br>(R <sub>S</sub> = 0, BW = 1.0 Hz, V <sub>DS</sub> = -15 Vdc, I <sub>D</sub> = -2.0 mAdc, f = 1.0 kHz) | e <sub>n</sub>      | —    | 300<br>120 | —<br>500 | NV/√Hz |

\*JEDEC Registered Limits

MOTOROLA SMALL-SIGNAL SEMICONDUCTORS

6367254 MOTOROLA SC (XSTRS/R F)

96D 82604 D

3N157, 3N158

T-37-25

FIGURE 1 - FORWARD TRANSCONDUCTANCE

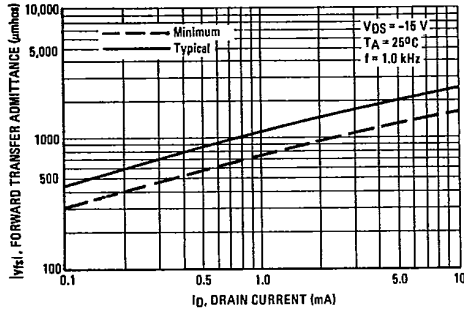


FIGURE 2 - OUTPUT TRANSCONDUCTANCE

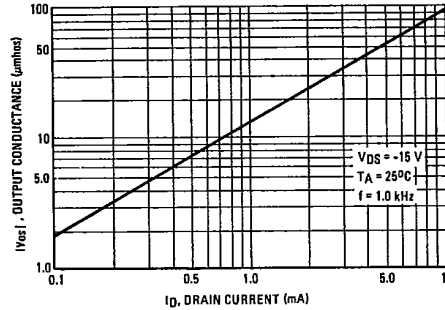


FIGURE 3 - FORWARD TRANSCONDUCTANCE versus TEMPERATURE

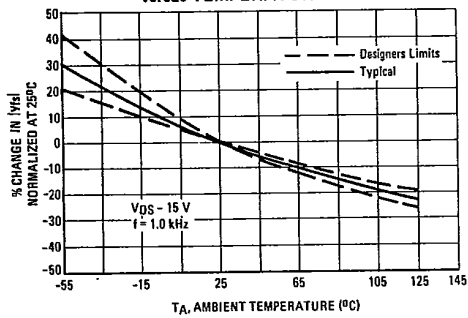


FIGURE 4 - BIAS CURVE

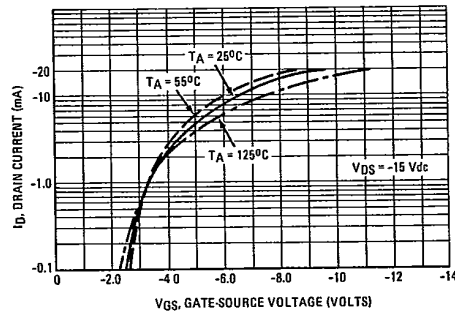


FIGURE 5 - "ON" DRAIN-SOURCE VOLTAGE

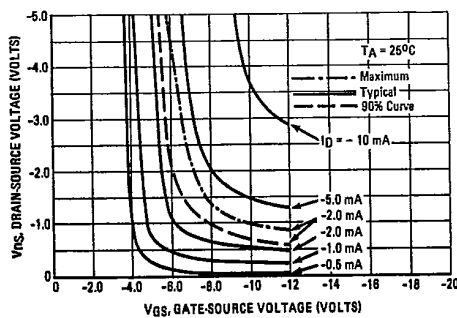
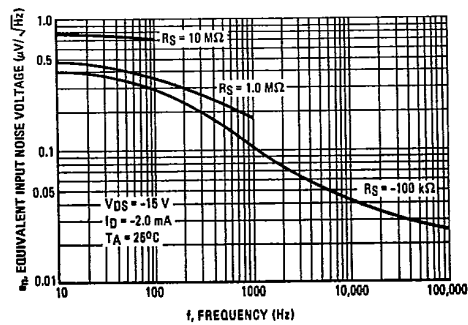


FIGURE 6 - EQUIVALENT INPUT NOISE VOLTAGE



6

6367254 MOTOROLA SC (XSTRS/R F)

96D 82605 D

3N157, 3N158

T-37-25

SWITCHING CHARACTERISTICS  
( $T_A = 25^\circ\text{C}$ )

FIGURE 7 – TURN-ON DELAY TIME

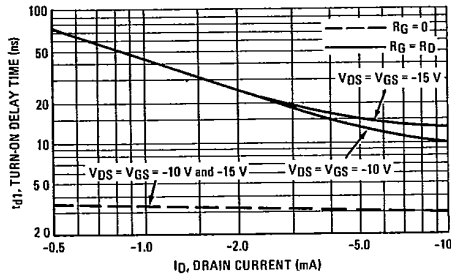


FIGURE 8 – RISE TIME

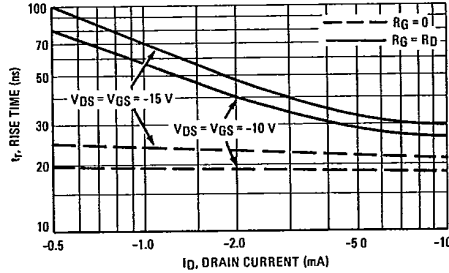


FIGURE 9 – TURN-OFF DELAY TIME

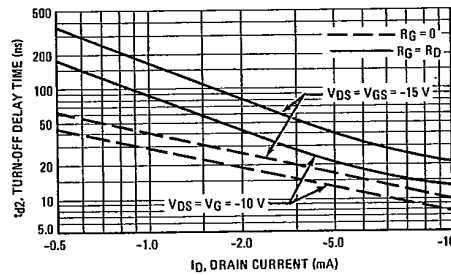


FIGURE 10 – FALL TIME

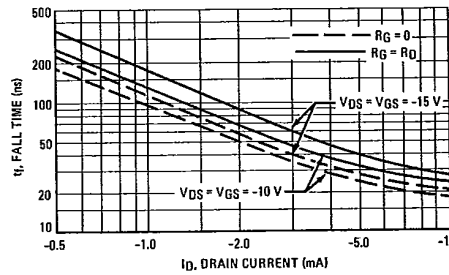


FIGURE 11 – SWITCHING CIRCUIT and WAVEFORMS

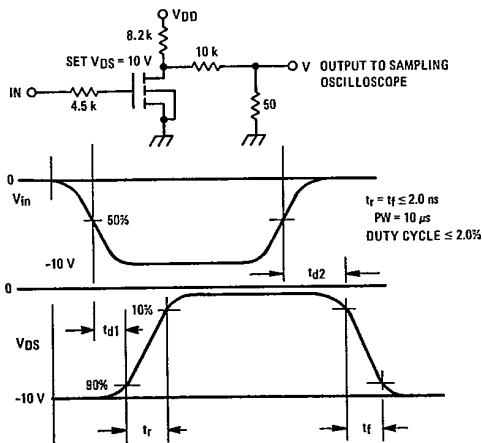
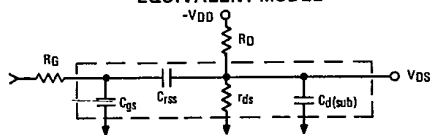


FIGURE 12 – SWITCHING CIRCUIT with MOSFET EQUIVALENT MODEL



The switching characteristics shown above were measured in a test circuit similar to Figure 11. At the beginning of the switching interval, the gate voltage is at ground and the gate source capacitance ( $C_{GS} \cdot C_{RSS} \cdot C_{RGS}$ ) has no charge. The drain voltage is at  $V_{DD}$  and thus the feedback capacitance ( $C_{RGS}$ ) is charged to  $V_{DD}$ . Similarly, the drain substrate capacitance ( $C_{d(sub)}$ ) is charged to  $V_{DD}$  since the substrate and source are connected to ground.

During the turn-on interval  $C_{GS}$  is charged to  $V_{GS}$  (the input voltage) through  $R_G$  (generator impedance) (Figure 12).  $C_{RSS}$  must be discharged to  $V_{GS} \cdot V_{D(on)}$  through  $R_G$  and the parallel combination of the load resistor ( $R_D$ ) and the channel resistance ( $r_{ds}$ ). In addition,  $C_{d(sub)}$  is discharged to a low value ( $V_{D(on)}$ ) through  $R_D$  in parallel with  $r_{ds}$ . During turn-off this charge flow is reversed.

Predicting turn-on time proves to be somewhat difficult since the channel resistance ( $r_{ds}$ ) is a function of the gate voltage ( $V_{GS}$ ). As  $C_{GS}$  becomes charged  $V_{GS}$  is approaching  $V_{in}$  and  $r_{ds}$  decreases (see Figure 5) and since  $C_{RSS}$  and  $C_{d(sub)}$  are charged through  $r_{ds}$ , turn-on time is quite non-linear.

If the charging time of  $C_{GS}$  is short compared to that of  $C_{RSS}$  and  $C_{d(sub)}$ , then  $r_{ds}$  (which is in parallel with  $R_D$ ) will be low compared to  $R_D$  during the switching interval and will largely determine the turn-on time. On the other hand, during turn-off  $r_{ds}$  will be almost an open circuit requiring  $C_{RSS}$  and  $C_{d(sub)}$  to be charged through  $R_D$  and resulting in a turn-off time that is long compared to the turn-on time. This is especially noticeable for the curves where  $R_G \cdot R_D$  and  $C_{GS}$  is charged through the pulse generator impedance only.

The switching curves shown with  $R_G \cdot R_D$  simulate the switching behavior of cascaded stages where the driving source impedance is normally the same as the load impedance. The set of curves with  $R_G \cdot 0$  simulates a low source impedance drive such as might occur in complementary logic circuits.